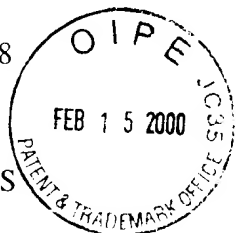


2811
11/9/99
1.527000
3.9.00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Perez, Erasmo; Roman, David T.
Assignee: Amkor Technology, Inc.
Title: SEMICONDUCTOR PACKAGE WITH EXPOSED DIE PAD AND
BODY-LOCKING LEADFRAME
Serial No.: 09/436,158 Filed: November 9, 1999
Examiner: Group Art Unit:
Docket No.: M-7744 US



San Jose, California

ASSISTANT COMMISSIONER FOR PATENTS
Washington, D. C. 20231

SUBMISSION OF SUPPLEMENTAL DECLARATION
FOR PATENT APPLICATION IN ACCORDANCE WITH 37 CFR 1.67 (A)

Dear Sir:

Pursuant to 37 CFR 1.67 (a) a Supplemental Declaration for Patent Application and Power of Attorney is submitted herewith. An executed Declaration for Patent Application and Power of Attorney was submitted with the filing papers of the above-identified patent application on November 9, 1999. However, the title of the application given in the Declaration was inaccurate. A Supplemental Declaration for Patent Application and Power of Attorney is submitted herewith to correct this inaccuracy.

The Commissioner is hereby authorized to charge any additional fees that may be required, or credit any overpayment to Deposit Account No. 19-2386.

Please telephone the undersigned at 949-718-6780, if there are any questions. This form is being submitted in duplicate.

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on Feb. 9, 2000.

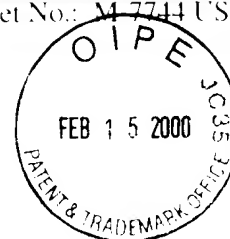
Don C. Lawrence 2/9/00
Attorney for Applicant(s) Date of Signature

Respectfully submitted,



Don C. Lawrence
Attorney for Applicant(s)
Reg. No. 31,975

DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY



As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below adjacent to my name.

I believe I am an original, first and joint inventor of subject matter (process, machine, manufacture, or composition of matter, or an improvement thereof) which is claimed and for which a patent is sought by way of the application entitled

Semiconductor Package with Exposed Die Pad and Body-Locking Leadframe

which (check) ☐ is attached hereto.
☐ and is amended by the Preliminary Amendment attached hereto.
☒ was filed on November 9, 1999 as Application Serial No. 09/436,158
☐ and was amended on (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information, which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America listed below and have also identified below any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date before that of the application(s) of which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
Number	Country	Day/Month/Year Filed	Yes	No
N/A			<input type="checkbox"/>	<input type="checkbox"/>

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:

Provisional Application Number	Filing Date
N/A	

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or PCT international application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information, which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56, which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application:

Application Serial No.	Filing Date	Status (patented, pending, abandoned)
N/A		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith:

Alan H. MacPherson (24,423); Brian D. Ogonowsky (31,988); David W. Heid (25,875); Norman R. Klivans (33,003); Edward C. Kwok (33,938); David E. Steuber (25,557); Michael Shenker (34,250); Stephen A. Terrile (32,946); Peter H. Kang (40,350); Ronald J. Meetin (29,089); Ken John Koestner (33,004); Omkar K. Suryadevara (36,320); David T. Millers (37,396); Kent B. Chambers (38,839); Michael P. Adams (34,763); Robert B. Morrill (43,817); Michael J. Halbert (40,633); Gary J. Edwards (41,008); William B. Tiffany (41,347); James E. Parsons (34,691); Daniel P. Stewart (41,332); Philip W. Woo (39,880); John T. Winburn (26,822); Tom Chen (42,406); Fabio E. Marino (43,339); William W. Holloway (26,182); Don C. Lawrence (31,975); Marc R. Ascolese (42,268); Carmen C. Cook (42,433); David G. Dolezal (41,711); Roberta P. Saxon (43,087); Bernice Chen (42,403); Mary Jo Bertani (42,321); Dale R. Cook (42,434); Sam G. Campbell (42,381); Matthew J. Brigham (44,047); Hugh H. Matsubayashi (43,779); Margaret M. Kelton (44,182); Joseph T. VanLeeuwen (44,383); Patrick D. Benedicto (40,909); T.J. Singh (39,535); Shireen Irani Bacon (40,494); Rory G. Bens (44,028); George Wolken, Jr. (30,441); John A. Odozynski (28,769); and Cameron K. Kerrigan (44,826).

Please address all correspondence and telephone calls to:

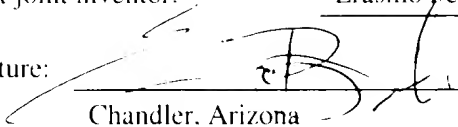
Don C. Lawrence
Attorney for Applicant(s)
SKJERVEN, MORRILL, MacPHERSON, FRANKLIN & FRIEL LLP
25 Metro Drive, Suite 700
San Jose, California 95110-1349

Telephone: 949-718-6780
Facsimile: 949-718-6799

fact, or makes any false, fictitious or fraudulent statements or representations, or makes or uses any false writing or document knowing the same to contain any false, fictitious or fraudulent statement or entry, shall be subject to the penalties including fine or imprisonment or both as set forth under 18 U.S.C. § 1001.

This document, or the validity of the claims, patent rights, or trademark rights, or any other right resulting therefrom

Full name of first joint inventor: Erasmo Perez

Inventor's Signature: 

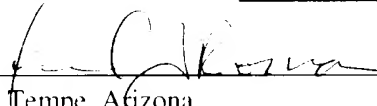
Date: 12/12/99

Residence: Chandler, Arizona

Post Office Address: 841 N. Layman Street
Chandler, AZ

Citizenship: U.S.A.

Full name of second joint inventor: David T. Roman

Inventor's Signature: 

Date: 12.2.99

Residence: Tempe, Arizona

Post Office Address: 428 W. Palomino Dr.
Tempe, AZ

Citizenship: U.S.A.